CY28352

Differential Clock Buffer/Driver DDR400- and DDR333 Compliant

Features

- **Supports 333-MHz and 400-MHz DDR SDRAM**
- **60- – 200-MHz operating frequency**
- **Phase-locked loop (PLL) clock distribution for double data rate synchronous DRAM applications**
- **Distributes one clock input to six differential outputs**
- **External feedback pin FBIN is used to synchronize output to clock input**
- **Conforms to DDRI specification**
- **Spread Aware™ for electromagnetic interference (EMI) reduction**
- **28-pin SSOP package**

Description

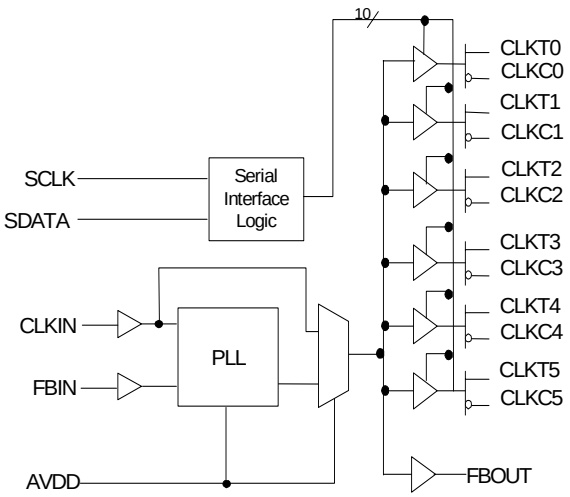
This PLL clock buffer is designed for 2.5-V_{DD} and 2.5-AV_{DD} operation and differential output levels.

This device is a zero delay buffer that distributes a clock input CLKIN to six differential pairs of clock outputs (CLKT[0:5], CLKC[0:5]) and one feedback clock output FBOUT. The clock outputs are controlled by the input clock CLKIN and the feedback clock FBIN.

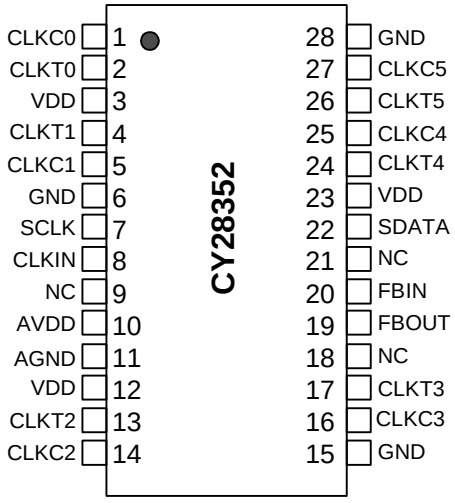
The two-line serial bus can set each output clock pair (CLKT[0:5], CLKC[0:5]) to the Hi-Z state. When AV_{DD} is grounded, the PLL is turned off and bypassed for test purposes.

The PLL in this device uses the input clock CLKIN and the feedback clock FBIN to provide high-performance, low-skew, low–jitter output differential clocks.

Block Diagram



Pin Configuration



28 pin SSOP

Pin Description[1]

Pin Number	Pin Name	I/O	Pin Description	Electrical Characteristics
8	CLKIN	I	**Complementary Clock Input**.	Input
20	FBIN	I	**Feedback Clock Input**. Connect to FBOUT for accessing the PLL.	Input
2,4,13,17,24, 26	CLKT(0:5)	O	**Clock Outputs**	Differential Outputs
1,5,14,16,25, 27	CLKC(0:5)	O	**Clock Outputs**	
19	FBOUT	O	**Feedback Clock Output**. Connect to FBIN for normal operation. A bypass delay capacitor at this output will control Input Reference/Output Clocks phase relationships.	Output
7	SCLK	I	**Serial Clock Input**. Clocks data at SDATA into the internal register.	Data Input for the two line serial bus
22	SDATA	I/O	**Serial Data Input**. Input data is clocked to the internal register to enable/disable individual outputs. This provides flexibility in power management.	Data Input and Output for the two line serial bus
3,12,23	VDD		**2.5V Power Supply for Logic**	2.5V Nominal
10	AVDD		**2.5V Power Supply for PLL**	2.5V Nominal
6,15,28	GND		**Ground**	
11	AGND		**Analog Ground for PLL**	
9, 18, 21	NC		**Not Connected**	

Zero Delay Buffer

When used as a zero delay buffer the CY28352 will likely be in a nested clock tree application. For these applications the CY28352 offers a clock input as a PLL reference. The CY28352 can then lock onto the reference and translate with near zero delay to low-skew outputs. For normal operation, the external feedback input, FBIN, is connected to the feedback output, FBOUT. By connecting the feedback output to the feedback input the propagation delay through the device is eliminated. The PLL works to align the output edge with the input reference edge thus producing a near zero delay. The reference frequency affects the static phase offset of the PLL and thus the relative delay between the inputs and outputs.

When V_{DDA} is strapped LOW, the PLL is turned off and bypassed for test purposes.

Power Management

The individual output enable/disable control of the CY28352 allows the user to implement unique power management schemes into the design. Outputs are three-stated when disabled through the two-line interface as individual bits are set low in Byte0 and Byte1 registers. The feedback output FBOUT cannot be disabled via two line serial bus. The enabling and disabling of individual outputs is done in such a manner as to eliminate the possibility of partial “runt” clocks.

Function Table

Inputs		Outputs			PLL
VDDA	CLKIN	CLKT(0:5)[2]	CLKC(0:5)[2]	FBOUT	
GND	L	L	H	L	BYPASSED/OFF
GND	H	H	L	H	BYPASSED/OFF
2.5V	L	L	H	L	On
2.5V	H	H	L	H	On
2.5V	<20 MHz	Hi-Z	Hi-Z	Hi-Z	Off

Notes:

1. A bypass capacitor (0.1µF) should be placed as close as possible to each positive power pin (< 0.2”). If these bypass capacitors are not close to the pins, their high-frequency filtering characteristic will be cancelled by the lead inductance of the traces.
2. Each output pair can be three-stated via the two-line serial interface.

Serial Control Registers

Following the acknowledge of the Address Byte, two additional bytes must be sent:

- Command Code byte
- Byte Count byte.

Byte0: Output Register1 (1 = Enable, 0 = Disable)

Bit	@Pup	Pin#	Description
7	1	2, 1	CLKT0, CLKC0
6	1	4, 5	CLKT1, CLKC1
5	1	–	Reserved
4	1	–	Reserved
3	1	13, 14	CLKT2, CLKC2
2	1	26, 27	CLKT5, CLKC5
1	1	–	Reserved
0	1	24, 25	CLKT4, CLKC4

Byte1: Output Register 2 (1 = Enable, 0 = Disable)

Bit	@Pup	Pin#	Description
7	1	–	Reserved
6	1	17, 16	CLKT3, CLKC3
5	0	–	Reserved
4	0	–	Reserved
3	0	–	Reserved
2	0	–	Reserved
1	0	–	Reserved
0	0	–	Reserved

Byte2: Test Register 3

Bit	@Pup	Pin#	Description
7	1	–	0 = PLL leakage test, 1 = disable test
6	1	–	Reserved
5	0	–	Reserved
4	0	–	Reserved
3	0	–	Reserved
2	0	–	Reserved
1	0	–	Reserved
0	0	–	Reserved

Maximum Ratings[3]

Input Voltage Relative to V_{SS}: ..... V_{SS} – 0.3V

Input Voltage Relative to VDDQ or AV_{DD}: ..... V_{DD} + 0.3V

Storage Temperature: .....–65°C to + 150°C

Operating Temperature: .....0°C to +70°C

Maximum Power Supply: 3.5V

This device contains circuitry to protect the inputs against damage due to high static voltages or electric field; however, precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range:

$V_{SS} < (V_{IN} \text{ or } V_{OUT}) < V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (either V_{SS} or V_{DD}).

DC Parameters $V_{DDA} = V_{DDQ} = 2.5V \pm 5\%$, $T_A = 0°C$ to $+70°C$[4]

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
VIL	Input Low Voltage	SDATA, SCLK			1.0	V
VIH	Input High Voltage	SDATA, SCLK	2.2			V
VIL	Input Voltage Low	CLKIN, FBIN			0.4	V
VIH	Input Voltage High	CLKIN, FBIN	2.1			V
IIN	Input Current	$V_{IN} = 0V$ or $V_{IN} = V_{DDQ}$, CLKIN, FBIN	–10		10	µA
IOL	Output Low Current	$V_{DDQ} = 2.375V$, $V_{OUT} = 1.2V$	26	35		mA
IOH	Output High Current	$V_{DDQ} = 2.375V$, $V_{OUT} = 1V$	–18	–32		mA
VOL	Output Low Voltage	$V_{DDQ} = 2.375V$, $I_{OL} = 12$ mA			0.6	V
VOH	Output High Voltage	$V_{DDQ} = 2.375V$, $I_{OH} = –12$ mA	1.7			V
VOUT	Output Voltage Swing[5]		1.1		$V_{DDQ} – 0.4$	V
VOC	Output Crossing Voltage[6]		$(V_{DDQ}/2) – 0.2$	$V_{DDQ}/2$	$(V_{DDQ}/2) + 0.2$	V
IOZ	High-Impedance Output Current	$V_O = GND$ or $V_O = V_{DDQ}$	–10		10	µA
IDDQ	Dynamic Supply Current[7]	All V_{DDQ} and V_{DDI}, FO = 170 MHz		235	300	mA
IDSTAT	Static Supply Current				1	mA
IDD	PLL Supply Current	V_{DDA} only		9	12	mA
Cin	Input Pin Capacitance			4	6	pF

AC Parameters $V_{DD} = V_{DDQ} = 2.5V \pm 5\%$, $T_A = 0°C$ to $+70°C$ [7, 9]

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
fCLK	Operating Clock Frequency		60		200	MHz
tDC	Input Clock Duty Cycle		40		60	%
tlock	Maximum PLL lock Time				100	µs
Tr / Tf	Output Clocks Slew Rate	20% to 80% of V_{OD}	1		2.5	V/ns
tpZL, tpZH	Output Enable Time[10] (all outputs)			3		ns
tpLZ, tpHZ	Output Disable Time[10] (all outputs)			3		ns
tCCJ	Cycle-to-Cycle Jitter[12]	f > 66 MHz	–100		100	ps
tjit(h-per)	Half-period jitter[12]	f > 66 MHz	–100		100	ps

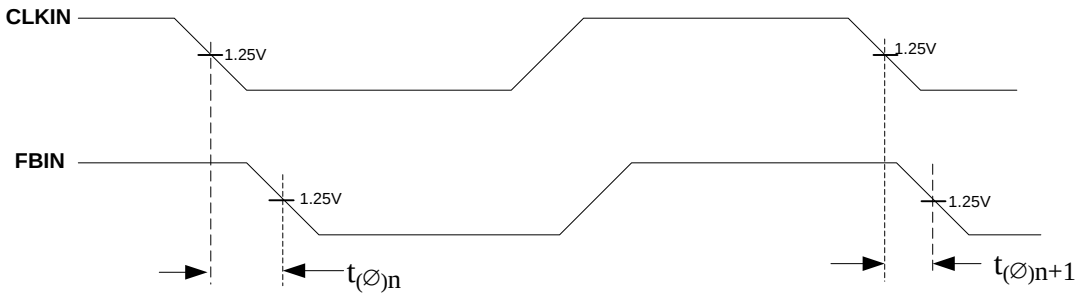
Notes:

3. Multiple Supplies: The voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.
4. Unused inputs must be held HIGH or LOW to prevent them from floating.
5. For load conditions, see *Figure 7*.
6. The value of V_{OC} is expected to be |VTR + VCP|/2. In case of each clock directly terminated by a 120Ω resistor. See *Figure 7*.
7. All outputs switching loaded with 16 pF in 60Ω environment. See *Figure 7*.
8. Parameters are guaranteed by design and characterization. Not 100% tested in production.
9. PLL is capable of meeting the specified parameters while supporting SSC synthesizers with modulation frequency between 30 kHz and 33.3 kHz, with a down spread of –0.5%.
10. Refers to transition of non-inverting output.
11. All differential input and output terminals are terminated with 120Ω/16 pF as shown in *Figure 7*.
12. Period Jitter and Half-Period Jitter specifications are separate, and must be met independently of each other.

AC Parameters $V_{DD} = V_{DDQ} = 2.5V \pm 5\%$, $T_A = 0°C$ to $+70°C$ (continued)[7, 9]

Parameter	Description	Condition	Min.	Typ.	Max.	Unit
tPLH	LOW-to-HIGH Propagation Delay, CLKIN to CLKT[0:5]		1.5	3.5	6	ns
tPHL	HIGH-to-LOW Propagation Delay, CLKIN to CLKT[0:5]		1.5	3.5	6	ns
tSKEW	Any Output to Any Output Skew[11]				100	ps
tPHASE	Phase Error[11]		–150		150	ps
tPHASEJ	Phase Error Jitter	f > 66 MHz	–50		50	ps

Parameter Measurement Information



$$t_{(\varnothing)n} = \frac{\sum_{1}^{n=N} t_{(\varnothing)n}}{} \quad \text{(N is large number of samples)}$$

Figure 1. Static Phase Offset

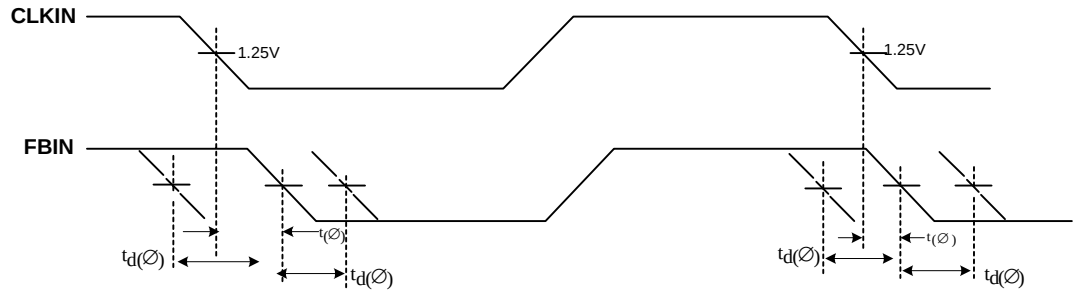


Figure 2. Dynamic Phase Offset

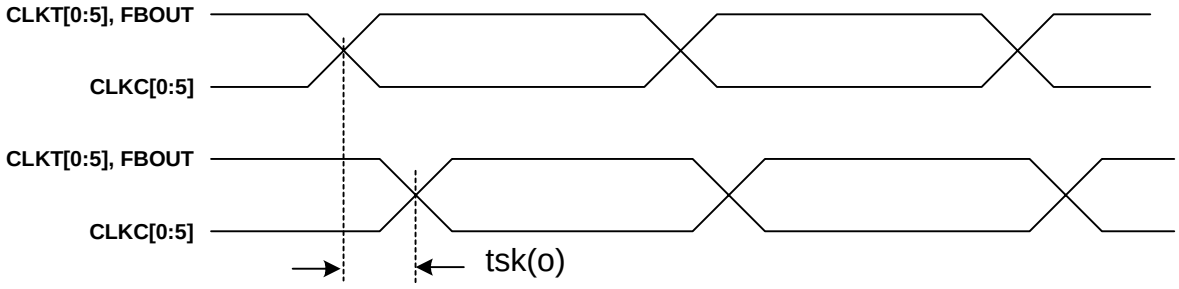
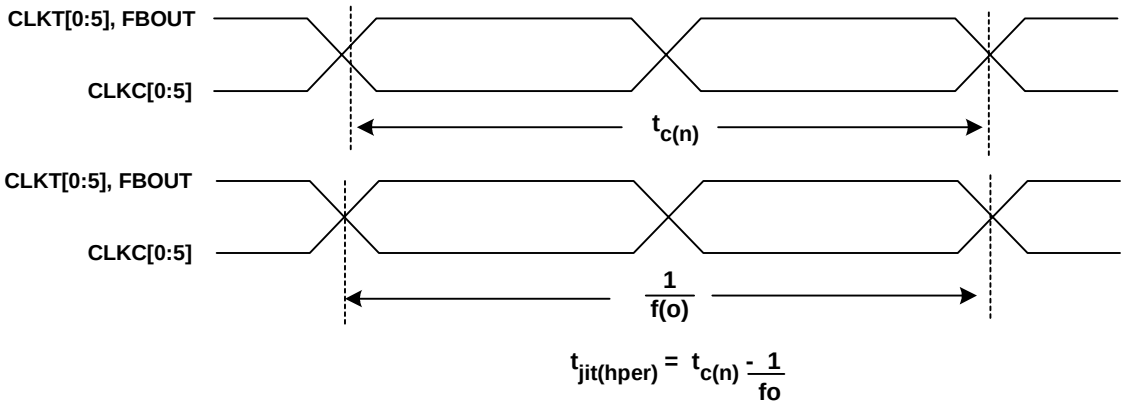
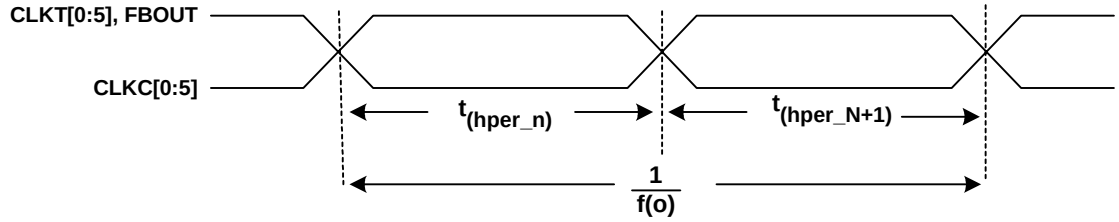


Figure 3. Output Skew



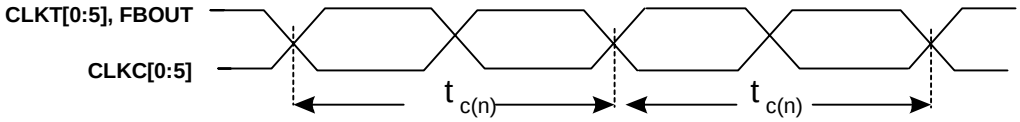
$$t_{jit(hper)} = t_{c(n)} - \frac{1}{fo}$$

Figure 4. Period Jitter



$$t_{jit(hper)} = t_{hper(n)} - \frac{1}{2x\ fo}$$

Figure 5. Half-period Jitter



$$t_{jit(cc)} = t_{c(n)} - t_{c(n+1)}$$

Figure 6. Cycle-to-Cycle Jitter

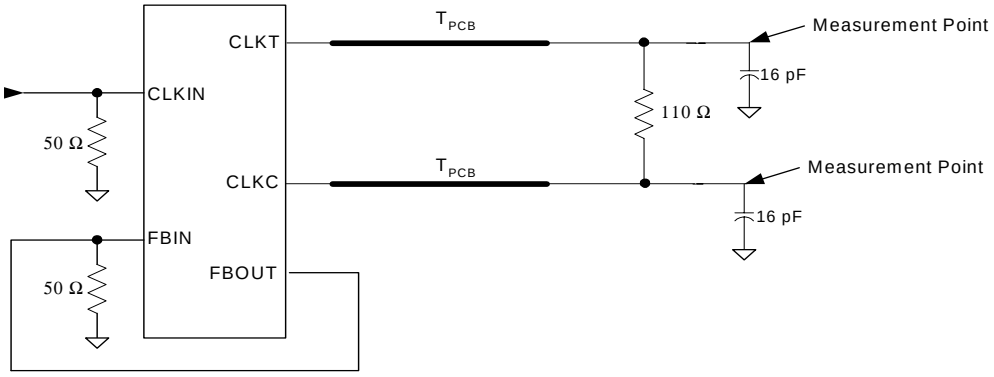


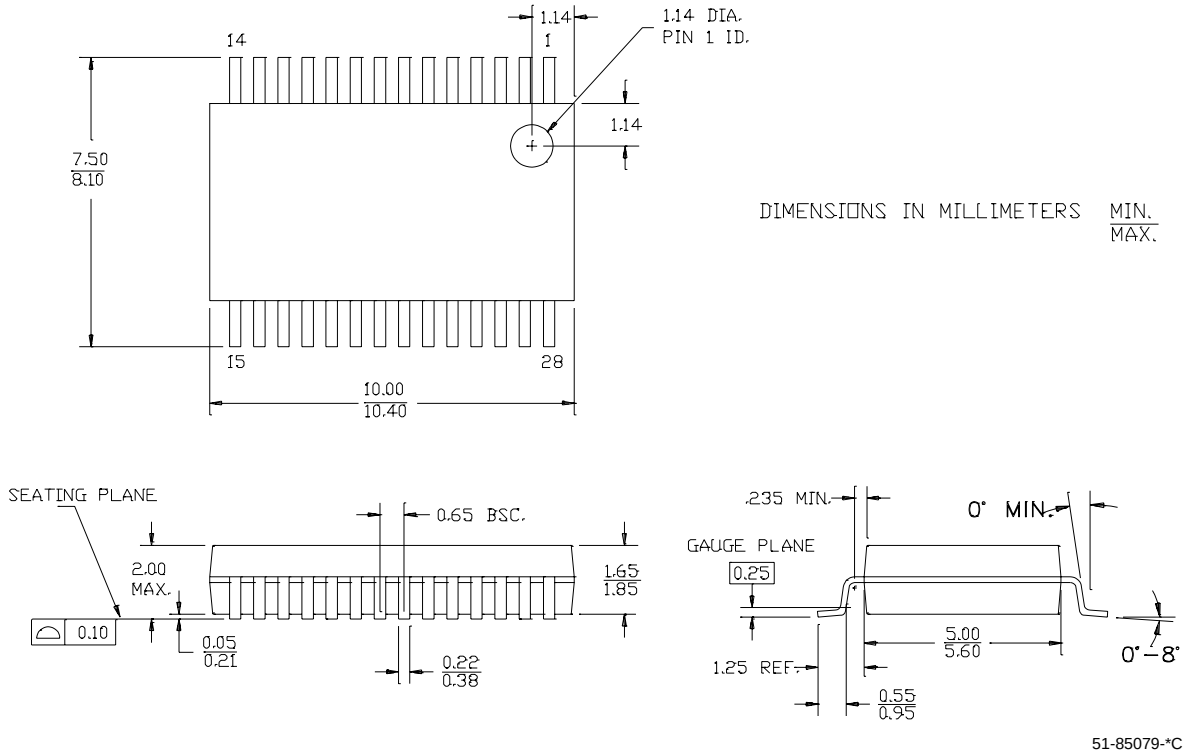
Figure 7. Differential Signal Using Direct Termination Resistor

Ordering Information

Part Number	Package Type	Product Flow
CY28352OC	28-pin SSOP	Commercial, 0° to 70°C
CY28352OCT	28-pin SSOP–Tape and Reel	Commercial, 0° to 70°C

Package Drawing and Dimensions

28-lead (5.3 mm) Shrunk Small Outline Package O28



Spread Aware is a trademark of Cypress Semiconductor. All product and company names mentioned in this document are the trademarks of their respective holders.

© Cypress Semiconductor Corporation, 2003. The information contained herein is subject to change without notice. Cypress Semiconductor Corporation assumes no responsibility for the use of any circuitry other than circuitry embodied in a Cypress Semiconductor product. Nor does it convey or imply any license under patent or other rights. Cypress Semiconductor does not authorize its products for use as critical components in life-support systems where a malfunction or failure may reasonably be expected to result in significant injury to the user. The inclusion of Cypress Semiconductor products in life-support systems application implies that the manufacturer assumes all risk of such use and in doing so indemnifies Cypress Semiconductor against all charges.

Document History Page

Document Title: CY28352 Differential Clock Buffer/Driver DDR400- and DDR333 Compliant, Document Number: 38-07371				
REV.	**ECN No.**	**Issue Date**	**Orig. of Change**	**Description of Change**
**	112787	05/08/02	DMG	New Data Sheet
*A	122911	12/27/02	RBI	Add power up requirements to maximum ratings information
*B	127012	05/28/03	RGL	Change the maximum operating clock frequency from 170MHz to 200MHz Added DDR400 and DDR333 Compliant in the title.